

January 2009

MOC8021M, MOC8050M Photodarlington Optocoupler (No Base Connection)

Features

- High BV_{CEO}
 - Minimum 50V (MOC8021M)
 - Minimum 80V (MOC8050M)
- High current transfer ratio:
 - Minimum 1,000% (MOC8021M)
 - Minimum 500% (MOC8050M)
- **■** 500%
- No base connection for improved noise immunity
- Underwriters Laboratory (UL) recognized File #E90700, Volume 2
- IEC 60747-5-2 approved (ordering option V)

Applications

- Appliances, measuring instruments
- I/O interface for computers
- Programmable controllers
- Portable electronics
- Interfacing and coupling systems of different potentials and impedance
- Solid state relays

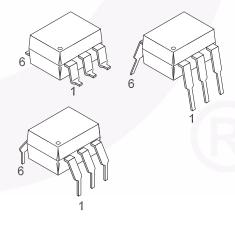
Description

The MOC8021M and MOC8050M are photodarlingtontype optically coupled optocouplers. The devices have a gallium arsenide infrared emitting diode coupled with a silicon darlington phototransistor.

Schematic

ANODE 1 6 N/C CATHODE 2 N/C 3 4 EMITTER

Package Outlines



Absolute Maximum Ratings (T_A = 25°C Unless otherwise specified.) Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Value	Units		
TOTAL DEVICE					
T _{STG}	Storage Temperature	-40 to +150	°C		
T _{OPR}	Operating Temperature	-40 to +100	°C		
T _{SOL}	Lead Solder Temperature (Wave solder)	260 for 10 sec	°C		
P _D	Total Device Power Dissipation @ T _A = 25°C	250	mW		
	Derate above 25°C	2.94	mW/°C		
EMITTER					
IF	DC/Average Forward Input Current	60	mA		
V _R	Reverse Input Voltage	3	V		
P _D	LED Power Dissipation @ T _A = 25°C	120	mW		
	Derate above 25°C	1.41	mW/°C		
DETECTOR					
V _{CEO}	Collector-Emitter Voltage				
	MOC8021M	50	V		
	MOC8050M	80			
P _D	Detector Power Dissipation @ T _A = 25°C	150	mW		
	Derate above 25°C	1.76	mW/°C		
I _C	Continuous Collector Current	150	mA		

Electrical Characteristics (T_A = 25°C Unless otherwise specified.)

Individual Component Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.*	Max.	Unit
EMITTER				,		
V _F	Input Forward Voltage	I _F = 10mA		1.18	2.00	V
I _R	Reverse Leakage Current	V _R = 3.0V		0.001	10	μΑ
DETECTO	R					
BV _{CEO}	Collector-Emitter Breakdown Voltage	I _C = 1.0mA, I _F = 0				
	MOC8021M		50	100		V
	MOC8050M		80	100		
BV _{ECO}	Emitter-Collector Breakdown Voltage	$I_E = 100 \mu A, I_F = 0$	5	10		V
I _{CEO}	Collector-Emitter Dark Current	V _{CE} = 60V, I _F = 0			1	μΑ
C _{CE}	Capacitance	V _{CE} = 0V, f = 1MHz		8		pF

Transfer Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.*	Max.	Unit
DC CHARA	CTERISTICS					
CTR	Current Transfer Ratio, Collector to Emitter					
	MOC8021M	$I_F = 10 \text{mA}, V_{CE} = 5 \text{V}$	1,000			%
	MOC8050M	$I_F = 10 \text{mA}, V_{CE} = 5 \text{V}$ $I_F = 10 \text{mA}, V_{CE} = 1.5 \text{V}$	500			
AC CHARA	CTERISTICS					
t _{on}	Non-Saturated Turn-on Time	$I_F = 5mA$, $V_{CC} = 10V$, $R_L = 100\Omega$		8.5		μs
t _{off}	Turn-off Time	$I_F = 5\text{mA}, V_{CC} = 10\text{V},$ $R_L = 100\Omega$		95		μs

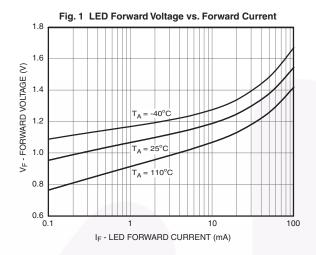
Isolation Characteristics

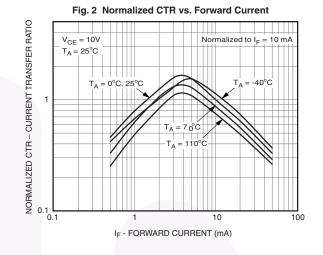
Symbol	Characteristic	Test Conditions	Min.	Тур.	Max.	Units
V _{ISO}	Input-Output Isolation Voltage	f = 60Hz, t = 1 sec.	7500			Vac(pk)
R _{ISO}	Isolation Resistance	V _{I-O} = 500VDC	10 ¹¹			Ω
C _{ISO}	Isolation Capacitance	$V_{I-O} = \emptyset$, $f = 1MHz$		0.2	2	pF

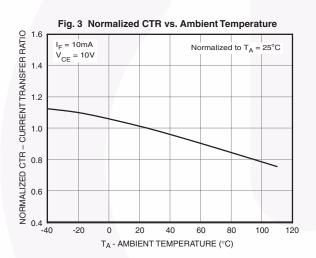
Note:

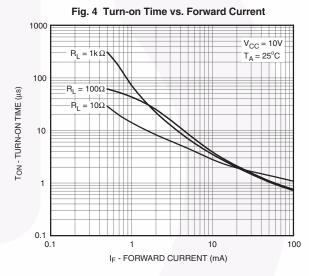
*Typical values at T_A = 25°C

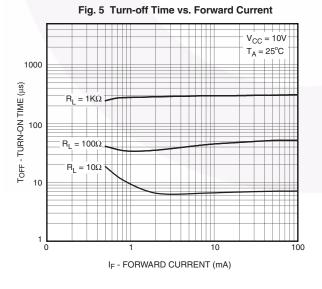
Typical Performance Curves

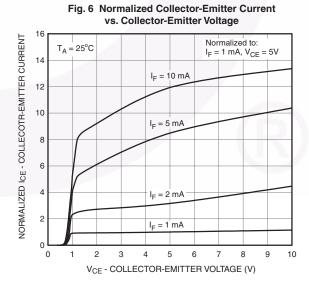




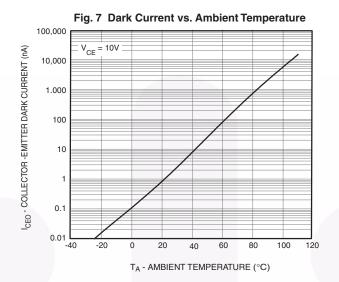




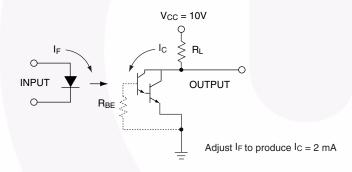




Typical Performance Curves (Continued)



TEST CIRCUIT



WAVE FORMS

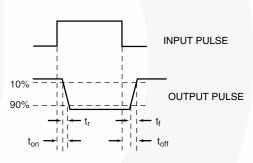
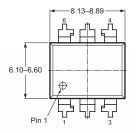
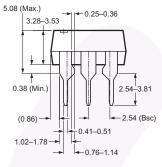


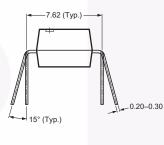
Figure 8. Switching Time Test Circuit and Waveforms

Package Dimensions

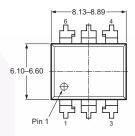
Through Hole

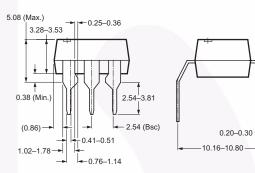




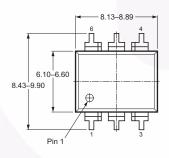


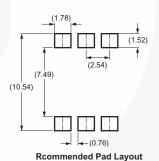
0.4" Lead Spacing

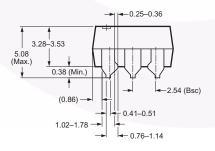


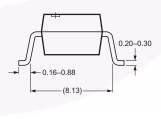


Surface Mount







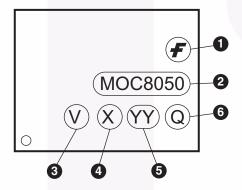


Note: All dimensions in mm.

Ordering Information

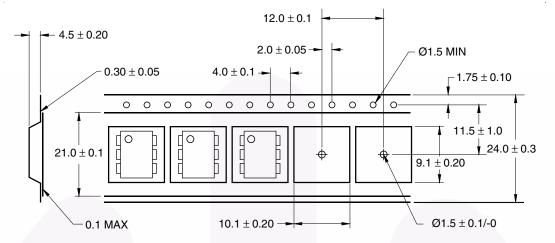
Option	Order Entry Identifier (Example)	Description
No suffix	MOC8050M	Standard Through Hole Device (50 parts per tube)
S	MOC8050SM	Surface Mount Lead Bend
SR2	MOC8050SR2M	Surface Mount; Tape and Reel
Т	MOC8050TM	0.4" Lead Spacing
V	MOC8050VM	IEC60747-5-2
TV	MOC8050TVM	IEC60747-5-2, 0.4" Lead Spacing
SV	MOC8050SVM	IEC60747-5-2, Surface Mount
SR2V	MOC8050SR2VM	IEC60747-5-2, Surface Mount, Tape and Reel

Marking Information



Definitions			
1	1 Fairchild logo		
2	Device number		
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)		
4	One digit year code, e.g., '7'		
5	Two digit work week ranging from '01' to '53'		
6	Assembly package code		

Tape Dimensions

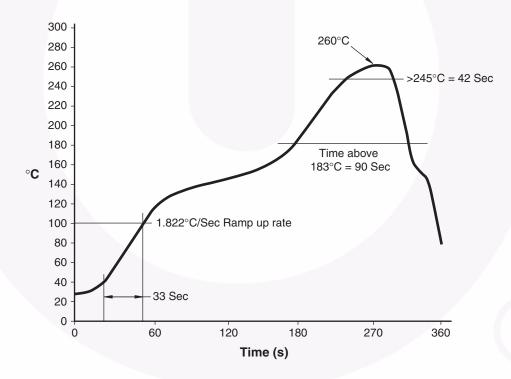


User Direction of Feed -----

Note:

All dimensions are in millimeters.

Reflow Soldering Profile







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